TSMC99-646B



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February 8, 2002 Co. Chiles -/a

To: Commissioner of Patents and Trademarks Washington, D.C. 20231

Fr: Stephen B. Ackerman, Reg. No. 37,761 20 McIntosh Drive Poughkeepsie, N.Y. 12603

Subject:

Serial No. 09/846,536

05/02/01

7 3-27-02

W. T. Chu et al.

"SELF ALIGNED, LOW CONTACT RESISTANCE, VIA FABRICATION PROCESS"

GRP. Art. Unit 2812

O. Nadav

RESPONSE PATENT OFFICE ACTION

Dear Sir;

In response to the Office Action dated December 03, 2001, please amend the identified application for patent as follows:

The commissioner is hereby authorized to charge payment of any additional fees involved with added Claims and the like to Deposit Account No. 19-0033

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231, on February 25, 2002,

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date 2 25 00